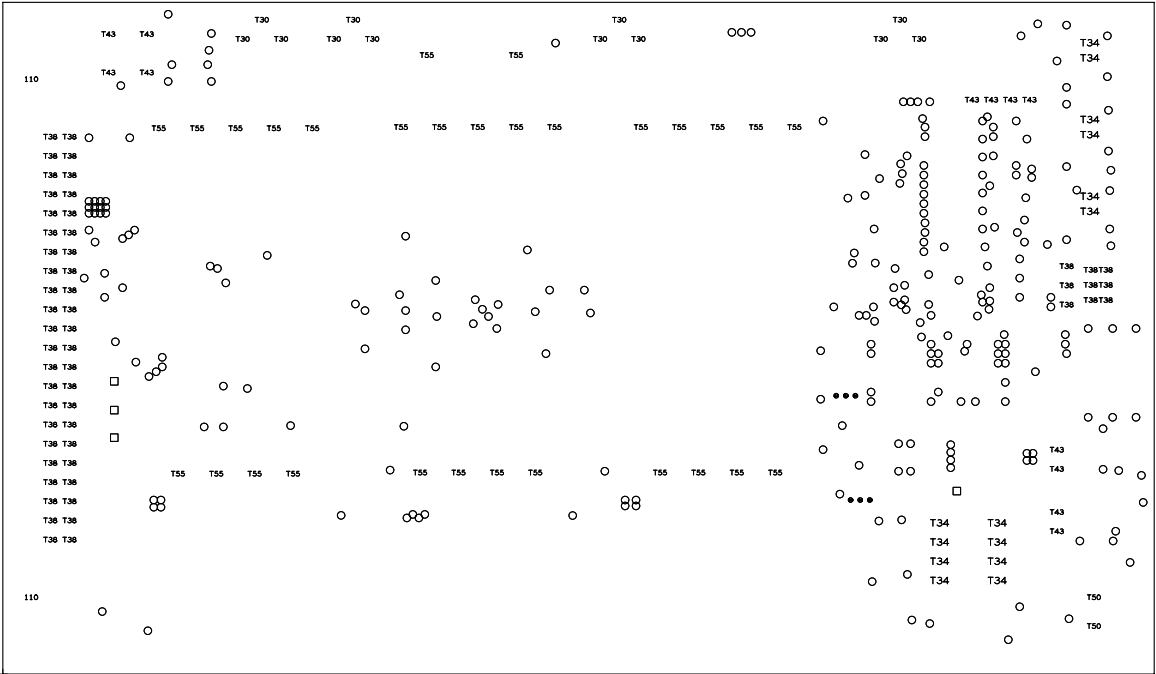


- CLASS II FABRICATION NOTES: (UNLESS OTHERWISE SPECIFIED)
1. BOARDS SHALL BE 100% NET LIST TESTED FOR OPENS AND SHORTS PER PROVIDED IPC-D-356 NETLIST.
 2. THIS BOARD SHALL BE MANUFACTURED IN ACCORDANCE WITH IPC-6012A CLASS II SPECIFICATIONS AND MEET IPC-600 CLASS II ACCEPTABILITY STANDARDS.
 3. MATERIAL:
 - a. FR4 PER IPC 4101B/24 /26 , OR /28.
 - b. SIGNAL LAYERS TO BE 2 OZ. COPPER.
 - c. PLANE LAYERS TO BE 2 OZ. COPPER.
 - d. OVERALL THICKNESS TO BE 0.062" +/- 0.003"
 4. LEGEND:
 - a. WHITE NON-CONDUCTIVE EPOXY INK BOTH SIDES.
 5. SOLDERMASK:
 - a. APPLY LIQUID PHOTO-IMAGABLE (LPI) SOLDER MASK OVER BARE COPPER PER IPC-SM-840 CLASS H, COLOR RED, BOTH SIDES.
 6. PLATING FINISH:
 - a. HOT AIR SOLDER LEVELING (HASL) SN63A SnPb SOLDER.
 7. PROCESS ALLOWANCES:
 - a. MAXIMUM BOW AND TWIST ACROSS DIAGONAL CORNERS OF THE BOARD SHALL NOT EXCEED 0.75%.
 - b. HOLE DIMENSIONS APPLY AFTER PLATING.
 - c. ALL HOLES SHALL BE LOCATED WITHIN 0.003" DIAMETER OF TRUE POSITION.
 - d. LAYER TO LAYER REGISTRATION SHALL BE WITHIN 0.003".
 - e. CONDUCTOR WIDTHS AND SPACING SHALL BE WITHIN +/- 0.002".
 - f. REMOVE ALL BURRS AND BREAK SHARP EDGES 0/015" MAX.
 - g. CUT OUTSIDE OF 0.001" BOARD OUTLINE.



DRILL CHART: TOP to BOTTOM			
ALL UNITS ARE IN MILS			
FIGURE	SIZE	PLATED	QTY
○	10.0	PLATED	265
□	16.0	PLATED	4
T30	30.0	PLATED	12
●	33.0	PLATED	6
T34	34.0	PLATED	14
T38	38.0	PLATED	53
T43	43.0	PLATED	12
T50	50.0	PLATED	2
T55	55.0	PLATED	29
110	110.0	PLATED	2

UNLESS OTHERWISE SPECIFIED	SIGNATURES	DATE	FOCE CHASSIS POWER SUPPLY			
			MONTEREY BAY AQUARIUM RESEARCH INSTITUTE 7700 SANDHOLDT ROAD MOSS LANDING, CA			
	DESIGNED BY: CHAD KEYC		SIZE B	REVISION A	DWG NO 10020556	
	LAYOUT BY: JOSE ROSAL		SCALE 1 - 1		SHEET	1 - 1